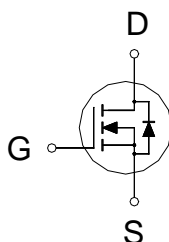


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

$BV_{DSS}$	20V
$R_{DS(on)} (MAX.)$	20m $\Omega$
$I_D$	6A



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ }^{\circ}\text{C}$  Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		$V_{GS}$	$\pm 12$	V
Continuous Drain Current	$T_A = 25\text{ }^{\circ}\text{C}$	$I_D$	6	A
	$T_A = 70\text{ }^{\circ}\text{C}$		4	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	24	
Power Dissipation	$T_A = 25\text{ }^{\circ}\text{C}$	$P_D$	1.25	W
	$T_A = 70\text{ }^{\circ}\text{C}$		0.8	
Operating Junction & Storage Temperature Range		$T_{j}, T_{stg}$	-55 to 150	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Ambient	$R_{\theta JA}$		100	$^{\circ}\text{C} / \text{W}$

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle  $\leq 1\%$

ELECTRICAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.35	0.65	1.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 12V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 16V, V_{GS} = 0V$			1	$\mu A$
		$V_{DS} = 16V, V_{GS} = 0V, T_J = 125\text{ }^{\circ}C$			10	
On-State Drain Current <sup>1</sup>	$I_{D(ON)}$	$V_{DS} = 5V, V_{GS} = 4.5V$	6			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 6A$		17	20	m $\Omega$
		$V_{GS} = 2.5V, I_D = 5A$		20	25	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = 5V, I_D = 6A$		7		S
DYNAMIC						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 10V, f = 1MHz$		560		pF
Output Capacitance	$C_{oss}$			166		
Reverse Transfer Capacitance	$C_{rss}$			150		
Total Gate Charge <sup>1,2</sup>	$Q_g$	$V_{DS} = 10V, V_{GS} = 4.5V,$ $I_D = 6A$		8.5		nC
Gate-Source Charge <sup>1,2</sup>	$Q_{gs}$			1.5		
Gate-Drain Charge <sup>1,2</sup>	$Q_{gd}$			3.5		
Turn-On Delay Time <sup>1,2</sup>	$t_{d(on)}$	$V_{DS} = 10V,$ $I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6\Omega$		12		nS
Rise Time <sup>1,2</sup>	$t_r$			15		
Turn-Off Delay Time <sup>1,2</sup>	$t_{d(off)}$			30		
Fall Time <sup>1,2</sup>	$t_f$			15		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T <sub>C</sub> = 25 °C)						
Continuous Current	$I_S$				2	A
Pulsed Current <sup>3</sup>	$I_{SM}$				8	
Forward Voltage <sup>1</sup>	$V_{SD}$	$I_F = I_S, V_{GS} = 0V$			1.2	V

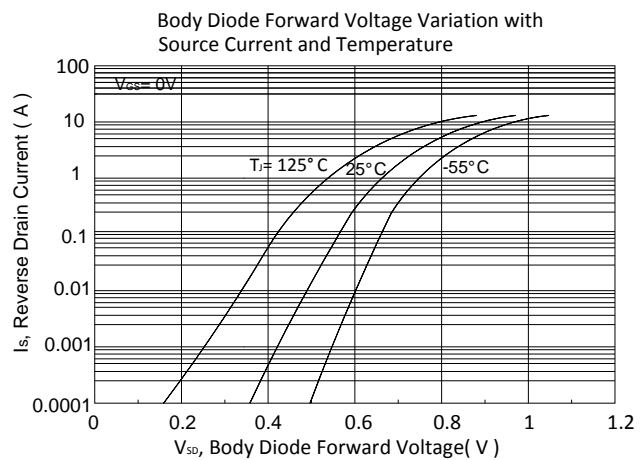
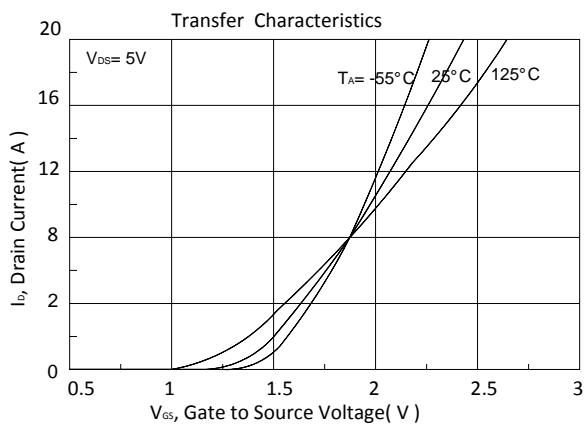
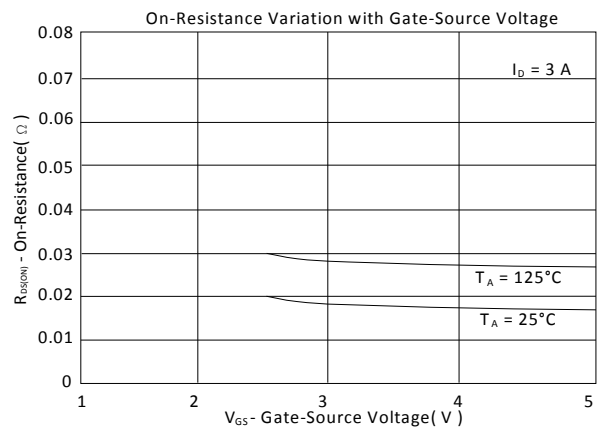
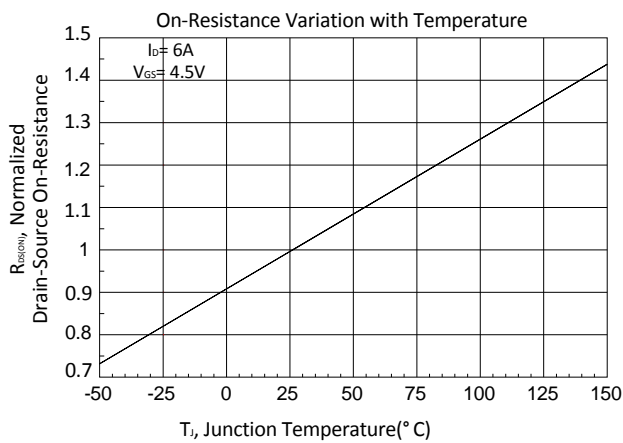
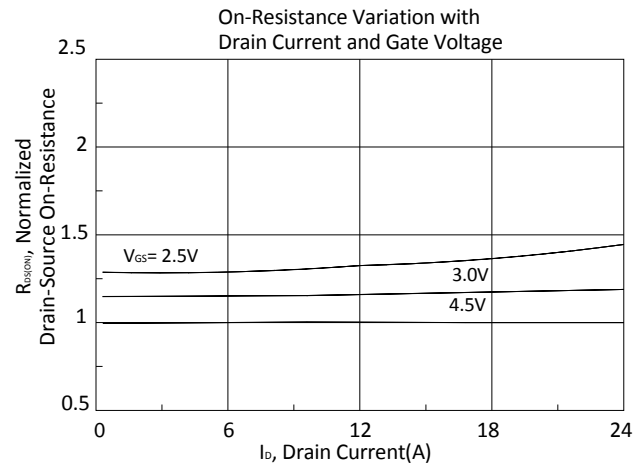
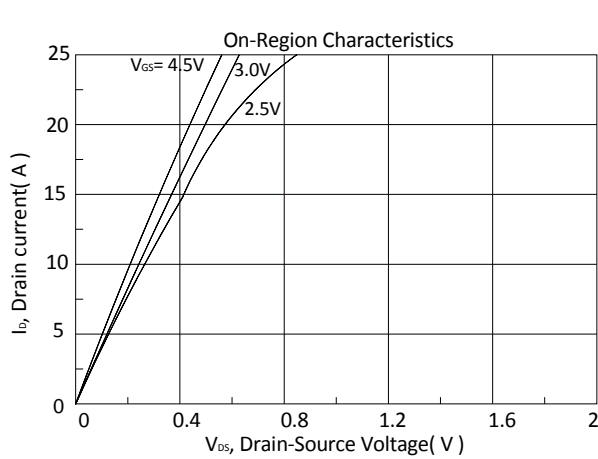
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\text{ }\mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

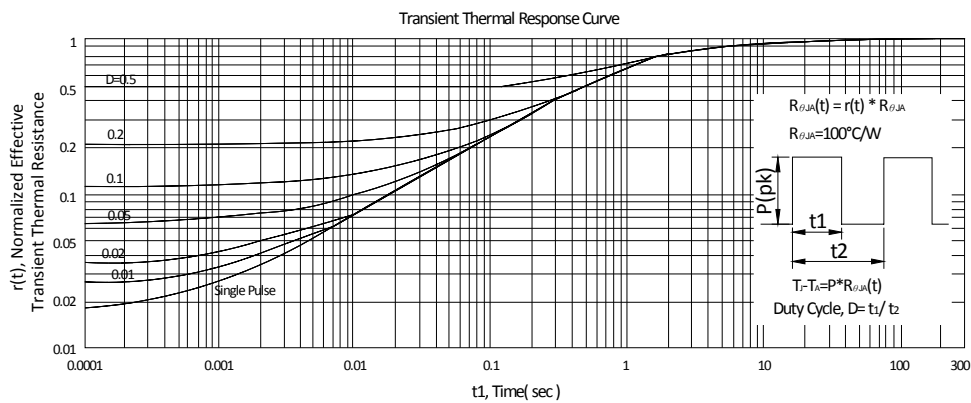
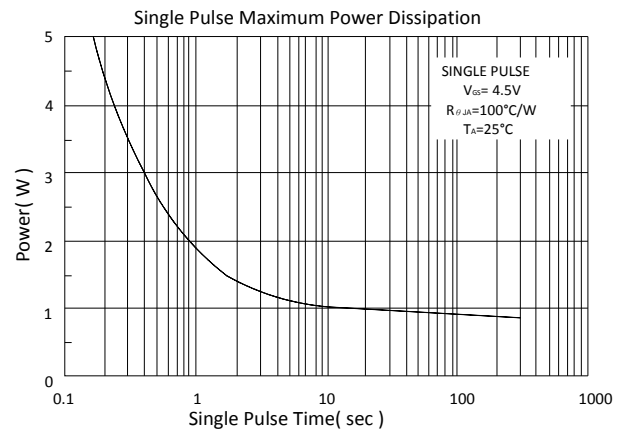
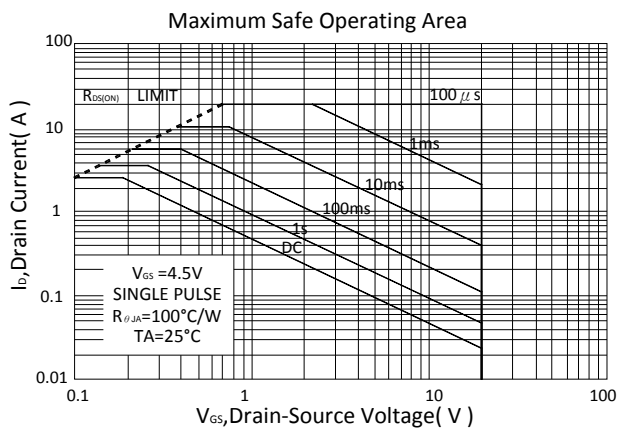
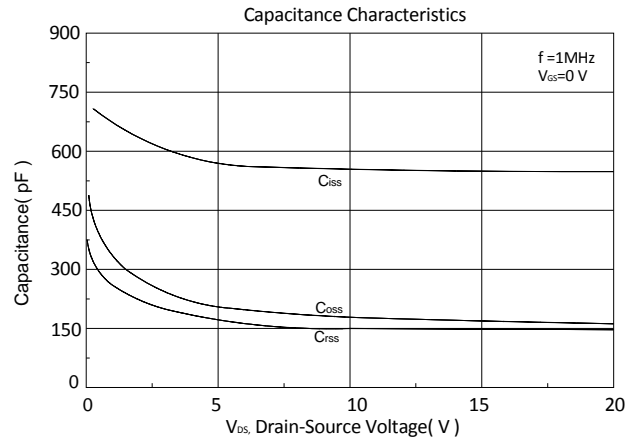
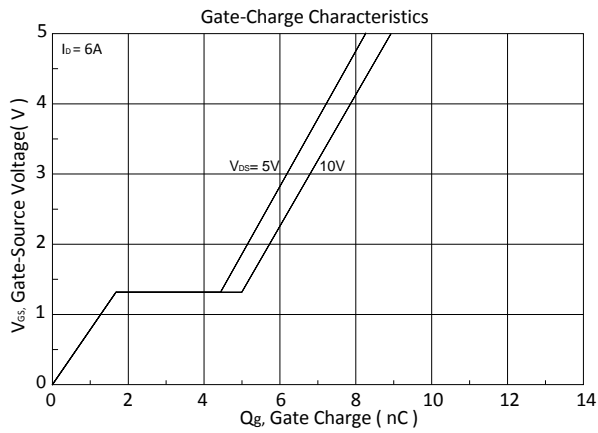
<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.



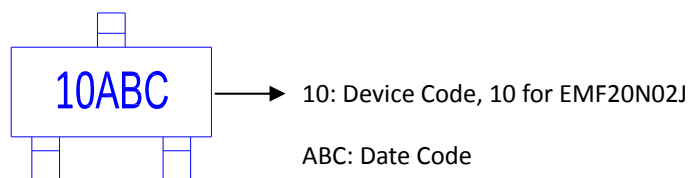
TYPICAL CHARACTERISTICS



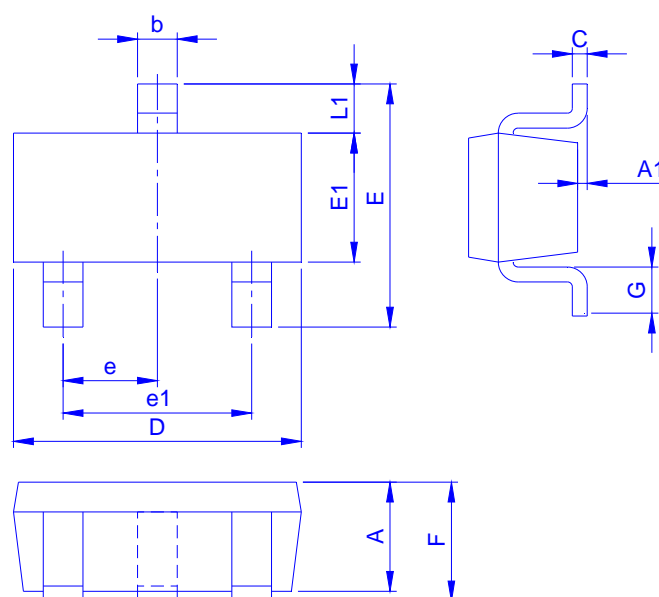


## Ordering & Marking Information:

Device Name: EMF20N02J for SOT-23



## Outline Drawing



## Dimension in mm

Dimension	A	A1	A2	b	C	D	E	E1	e	e1	F	G	L1
Min.	0.7	0		0.35	0.1	2.8	2.6	1.5	0.9		0.8	0.3	0.55
Typ.						2.9	2.8	1.6	0.95	1.9			
Max.	1.12	0.1		0.5	0.2	3	3	1.7	1		1.2	0.6	0.65

## Footprint

